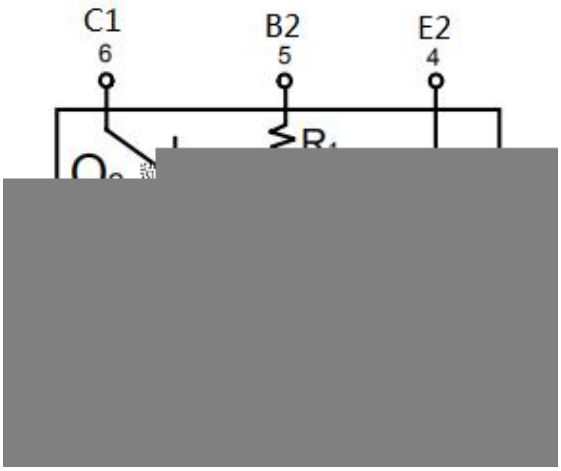
A	2020.08.21		LRC-LMUN5313DW1T1G		
B	2021-11-25	6			

SOT-363 NPN+PNP
Double NPN PNP



Q1:PNP
Q2:NPN

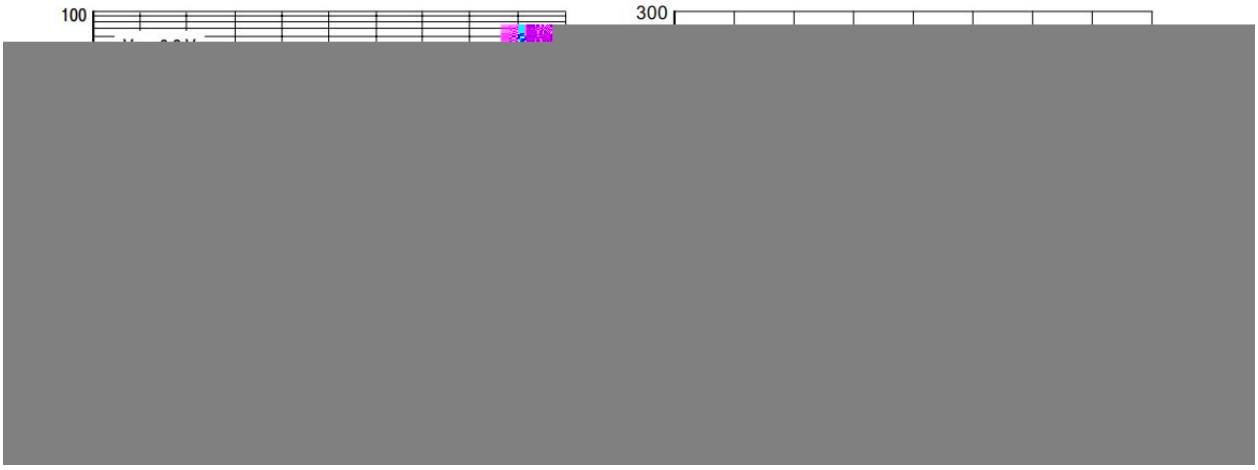
			℃
		～	℃

			℃
		～	℃

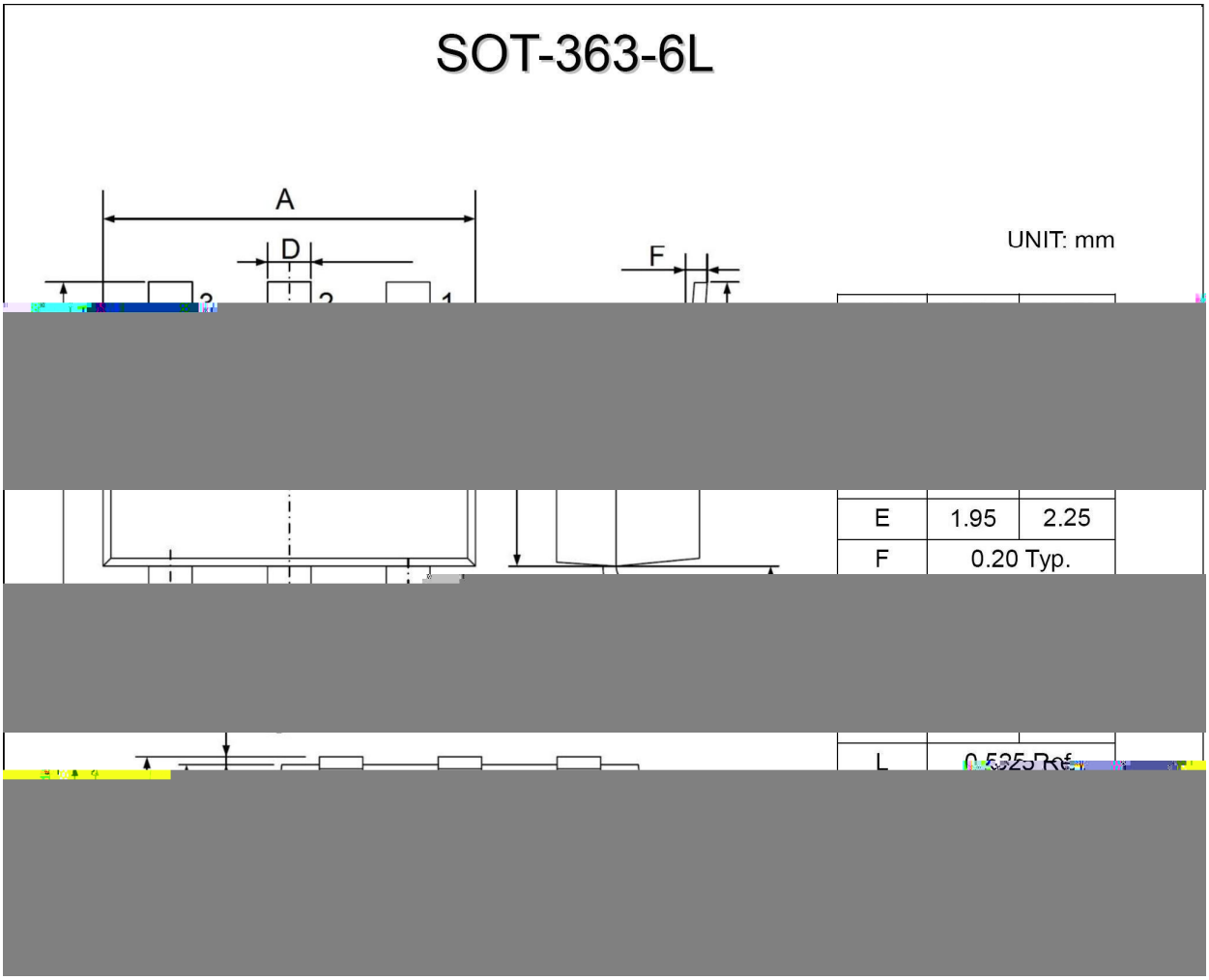
		μ				

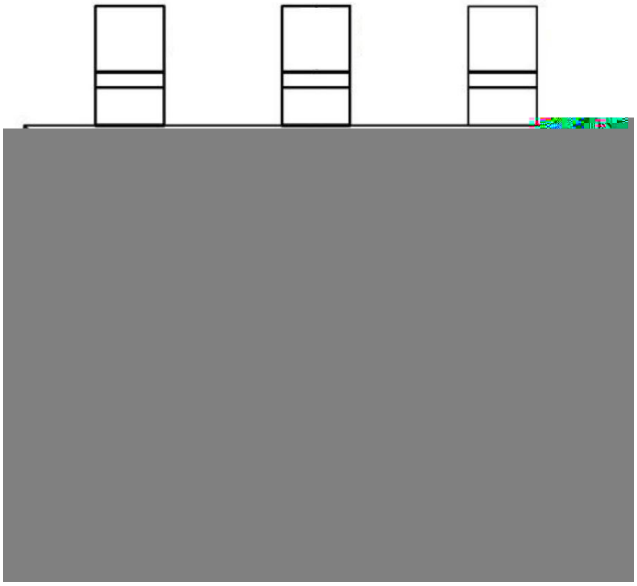
10
1000

1
100


100
300

SOT-363-6L





- “ 1 ”

H313

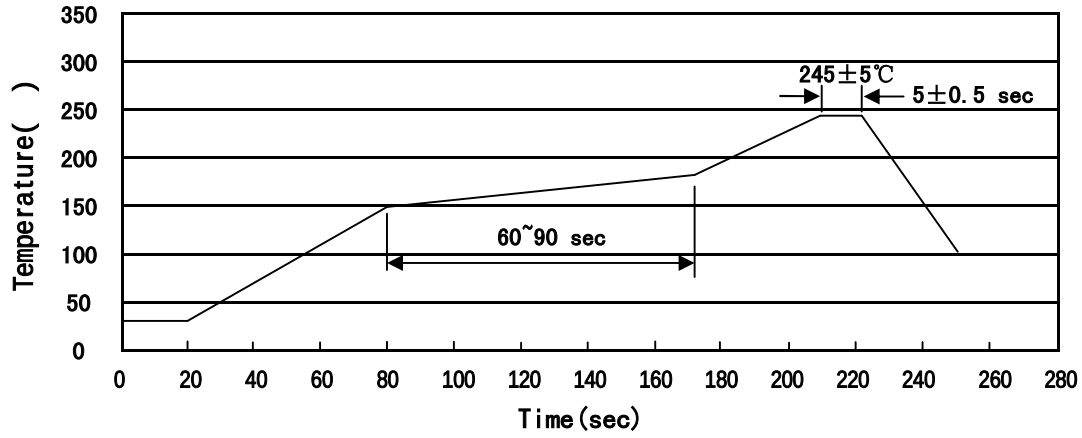
***:

- “1” Pin

H313

***:

Temperature Profile for IR Reflow Soldering(Pb-Free)



℃

± ± ± ℃ ±

℃ ℃

± ℃ ± ℃

	Units/Reel 只/卷盘	Reels/Inner Box 卷盘/盒	Units/Inner Box 只/盒	Inner Boxes/Outer Box 盒/箱	Units/Outer Box 只/箱	Reel	Inner Box	Outer Box
SOT-363	3,000	10	30,000	6	180000	7″ ×8	180×120×180	390×385×205